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**IN THE CLAIMS:** 

Please amend the claims as follows:

Claims 1-2 (Canceled).

Claim 3 (Original): A radiation detector comprising:

radiation detecting means for detecting incident radiation to output a detected signal,

signal processing means for processing the detected signal from the radiation detecting

means, and

a wiring substrate section having a wiring substrate with a conduction path provided for

guiding the detected signal between a signal input surface and a signal output surface, the

radiation detecting means and the signal processing means being connected to the signal input

surface and the signal output surface, respectively, wherein

the wiring substrate includes a glass substrate formed of a predetermined glass material

having a radiation shielding function and provided with a through hole, and a conductive

member provided in the through hole to serve as the conduction path for establishing electrical

continuity between the signal input surface and the signal output surface, and

the radiation detecting means, the wiring substrate section, and the signal processing

means are located in that order along a predetermined alignment direction, while an opening of

the through hole provided in the wiring substrate from the signal input surface to the signal

output surface is blocked with a shield member having a radiation shielding function.

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Claim 4 (Original): The radiation detector according to Claim 3, wherein the shield

member is configured such that a predetermined shield material having a radiation shielding

function is filled in the through hole.

Claim 5 (Original): The radiation detector according to Claim 3, wherein the shield

member is a bump electrode which is formed of a predetermined shield material having a

radiation shielding function and which is electrically connected to the conductive member

provided in the through hole.

Claims 6-12 (Canceled).

Claim 13 (Previously Presented): The radiation detector according to Claim 3, wherein

the glass substrate is formed of the glass material that contains lead.

Claim 14 (Previously Presented): The radiation detector according to Claim 3, wherein

the conductive member is formed on an inner wall of the through hole provided in the glass

substrate.

Claim 15 (Previously Presented): The radiation detector according to Claim 3, wherein

the conductive member is filled in the through hole provided in the glass substrate.

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Claim 16 (Previously Presented): The radiation detector according to Claim 3, wherein

the glass substrate is provided with the plurality of through holes while a plurality of hollow

glass members that are open at both ends are fused together and integrally formed.

Claim 17 (Previously Presented): The radiation detector according to Claim 3, wherein

the radiation detecting means includes a scintillator for generating scintillation light by radiation

made incident, and a semiconductor photodetecting element for detecting the scintillation light

from the scintillator.

Claim 18 (Previously Presented): The radiation detector according to Claim 3, wherein

the radiation detecting means includes a semiconductor detecting element for detecting radiation

made incident thereon.

Claim 19 (Previously Presented): The radiation detector according to Claim 3, wherein at

least either the wiring substrate section and the radiation detecting means or the wiring substrate

section and the signal processing means are electrically connected to each other via a bump

electrode.